



# Product Change Notification

**Change Notification #:** 115307-00  
**Change Title:** Intel® Server Chassis H2312XXKR2  
PCN115307-00, Product Material, Label,  
Board-specific Quick Reference Label (QRL)  
Removal  
**Date of Publication:** February 15, 2017

## Key Characteristics of the Change:

Product Material, Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	March 06, 2017
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## Description of Changes to the Customer:

Intel is removing the board-specific QRL from the chassis (H39759-002) in replacement for the chassis-only QRL (H70975-002).

Please refer to the Products Affected table below for a summary of TA changes.

- Figure 1. Current (pre-change)
- Figure 2. New (post-change)

Figure 1. Current (pre-change)

## Quick Reference

IMPORTANT NOTE: Please read all Warnings/Cautions before servicing this product!

### Front Panel Feature Identification

3.5" Drive Identification - 12 Drive Configuration

2.5" Drive Identification - 16 Drive Configuration

### Back Panel Feature Identification

Ports: NIC 1 (RJ45), NIC 2 (RJ45), Video Port (VGA), 2x Stacked USB 2.0 Ports, Dedicated Management Port (RJ45), InfiniBand\* Port (QSFP+)

Buttons: Power Button with LED, Status LED, ID Button with LED, Network Link/Activity LED

### Server Board Configuration Diagram

MC LED Functions:

LED	Color	LED State	MC State
Left	Green	Off	LAN link is not established.
		Blinking	LAN activity is occurring.
Right	Blue	Off	10 Mbit/sec. data rate is selected.
		On	100 Mbit/sec. data rate is selected.
		Green	1 Gbit/sec. data rate is selected.

Intel® Server Board S2600KP

Intel® Server Board S2600TP

H39759-002

### Protective Cap Removal

**CAUTION** Remove the protective cap from the bridge board before inserting the compute module into the chassis.

### Compute Module Installation

**A** Align and slide the compute module into the chassis.

**B** While pressing the latch, push the compute module along the chassis rail until the latch locks in position.

### Power Supply Installation

**A** Align and slide the power supply into the power cage.

**B** While pressing the latch, push the power supply along the power cage rail until the latch locks in position.

**WARNING** Hot Surfaces: Allow system components to cool before touching.

**WARNING** The power distribution module cover must be in place when system is powered ON.

**CAUTION** Observe normal ESD (Electrostatic Discharge) procedures during system integration to avoid possible damage to server board and/or other components.

**WARNING** Prior to performing the listed procedures on non-hot swappable components, you must power down the system and remove the power cord.

**CAUTION** Danger of explosion if battery is replaced incorrectly. The lithium battery in the mainline clock must be replaced with the same or equivalent type part. Contact your service representative to obtain a qualified replacement part. Dispose of used parts in accordance with local regulations. **DO NOT** dispose of in fire.

**CAUTION** Systems can weigh up to 92lbs (42kg). It is highly recommended to have two people when lifting the system.

RED DOTTED LINES AND CROP MARKS DO NOT PRINT!

Figure 2. New (post-change)

## Quick Reference IMPORTANT NOTE: Please read all Warnings/Cautions before servicing this product!

### Front Panel Feature Identification

**3.5" Drive Identification - 12 Drive Configuration**

**2.5" Drive Identification - 16 Drive Configuration**

**2.5" Drive Identification - 24 Drive Configuration**

Note: Please refer to the technical product specification for compatible compute module.

### Back Panel Feature Identification

Network Link/Activity LED  
Power Button with LED  
Status LED  
ID Button with LED

#### Protective Cap Removal

**CAUTION** Remove the protective cap from the bridge board before inserting the compute module into the chassis.

#### Power Supply Installation

**A** Align and slide the power supply into the power cage.

**B** While pressing the latch, push the power supply along the power cage rail until the latch locks in position.

**WARNING** Hot Surfaces Allow system components to cool before touching.

**CAUTION** Systems can weigh up to 92lbs (42kg). It is highly recommended to have two people when lifting the system.

**Warning!** Prior to performing the listed procedures on non-hot swappable components, you must power down the system and remove the power cord.

#### Compute Module Installation

**A** Align and slide the compute module into the chassis.

**B** While pressing the latch, push the compute module along the chassis rail until the latch locks in position.

**Warning!** The power distribution module cover must be in place when system is powered ON.

**CAUTION** Observe normal ESD (Electrostatic Discharge) procedures during system integration to avoid possible damage to server board and/or other components.

**CAUTION** Danger of explosion if battery is replaced incorrectly. The lithium battery in the real-time clock must be replaced with the same or equivalent type part. Contact your service representative to obtain a qualified replacement part. Dispose of used parts in accordance with local regulations. **DO NOT** dispose of in fire.

H70975-002

↑ RED DOTTED LINES AND CROP MARKS DO NOT PRINT! ↓

### **Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

### **Products Affected / Intel Ordering Codes:**

<b>Product Code</b>	<b>MM#</b>	<b>Pre Change TA</b>	<b>Post Change TA</b>
H2312XXKR2	933689	H20865-008	H20865-009

### **PCN Revision History:**

**Date of Revision:**

February 15, 2017

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

## 115307-00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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